

PCT

WORLD INTELLECTUAL PROPERTY ORGANIZATION International Bureau

INTERNATIONAL APPLICATION PUBLISHED UNDER THE PATENT COOPERATION TREATY (PCT)

(51) International Patent Classification 6: H01Q 11/12, 1/36, G08B 13/14, 26/00 (11) International Publication Number:

WO 98/40930

(43) International Publication Date: 17 September 1998 (17.09.98)

MC, NL, PT, SE).

(21) International Application Number:

PCT/US98/04099

A1

(22) International Filing Date:

3 March 1998 (03.03.98)

(30) Priority Data:

60/040,143

10 March 1997 (10.03.97)

Published US

PRECISION DYNAMICS CORPORATION (71) Applicant: [US/US]; 13880 Del Sur Street, San Fernando, CA 91340

(72) Inventor: BEIGEL, Michael, L.; 1982 Sage Avenue, Corona, CA 91720 (US).

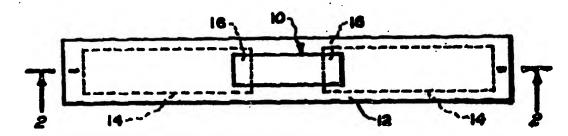
(74) Agent: MAHONEY, Thomas, P.; Suite 710, 660 Newport Center Drive, Newport Beach, CA 92660 (US).

With international search report.

Before the expiration of the time limit for amending the claims and to be republished in the event of the receipt of amendments.

(81) Designated States: AU, BR, CA, JP, MX, European patent (AT, BE, CH, DE, DK, ES, FI, FR, GB, GR, IE, IT, LU,

(54) Title: REACTIVELY COUPLED ELEMENTS IN CIRCUITS ON FLEXIBLE SUBSTRATES



(57) Abstract

An RFID circuit for incorporation in an identification device which includes a polymeric substrate (12), the circuit being formed or integrally connected with said substrate whereby the substrate becomes a component of the RFID circuit. An embodiment of the circuit includes circuit elements (10, 14) printed or attached to opposite sides of the substrate utilizing the resistance of the substrate in a reactive or inductive circuit.

FOR THE PURPOSES OF INFORMATION ONLY

Codes used to identify States party to the PCT on the front pages of pamphlets publishing international applications under the PCT.

AL AM AT AZ BA BB BB BB BB BC CF CG CT	Azerbaijan Bosnia and Herzegovima Barbados Belgium Burkina Faso Bulgaria Benia Brazil Belarus Canada Central African Republic Congo Switzertand	ES FI FR GA GB GH GN GN HU IB IL IS IT JP KE	Finland Prance Gabon United Kingdom Georgia Chana Guinea Greece Hungary treland Izmel Iceland Italy Japan Kenya	LS LT LU LV MC MD MG MK MI MN MR MN MR NS NS	LT Lithunia LU Lutenbourg LV Latvia MC Monaco MD Republic of Moldova MG Medagascar MK The former Yugoslav Republic of Macedonia MIL Mail MN Mongolia MR Mearttania MW Malawi MW Malawi MK Mcsico NE Nigor NL Netherlands	SI SK SN SZ TD TG TJ TM TR TR UA UG US VN YU	Slovenia Slovakia Senegal Swaziland Chad Togo Tajikistan Turkery Trinidad and Tobago Ukraine Uganda United States of America Uzbekistan Viet Nam Yugoslavia
BG BJ BR BY CA CIP CG	Bulgaria Benin Brazil Belarus Canada Central African Republic Conpo	HU IR IL IS IT JP	Hungary freland Israel Iceland Italy Japan	MN MR MW MX NB	Mati Mongolia Msautunia Msauti Msauti Nigor	IT UA UG US UZ VN	Trinidad and Tobago Ulcrains Uganda United States of America Uzbekistan Viet Nam
CI CM CN CU CZ DE DK	Côte d'Ivoire Cameroon China Cuba Czech Republic Germany Denmark	KP KR KZ LC U LK	Democratic People's Republic of Korea Republic of Korea Kazaksten Saint Lucta Liechtenstein Sri Lunka	NO NZ PL PT RO RU SD SB	Norway New Zealand Poland Portugal Romania Russian Federation Sudan Sweden	z₩	Zimbabwe
er er	Denmark Estonia	LR LR	Sri Leeka Liberia	SB SG	Sweden Singapore		

REACTIVELY COUPLED ELEMENTS IN CIRCUITS ON FLEXIBLE SUBSTRATES

This application claims the benefit of U.S. Provisional Application No. 60/040,143, filed March 10, 1997.

This invention relates to RF circuits and, more particularly, to reactively coupled elements of said circuits, particularly those disposed on flexible substrates.

10 Background of the Invention

5

20

25

It is well known to those skilled in the art that the goal in the design and manufacture of RFID tags is to provide low-cost miniature components which, when assembled, will be susceptible of incorporation in a wide variety of applications where miniaturization and low cost are requisite.

Typical of prior art attempts at miniaturization and low cost are the arrangement of the components of the circuit in a uniform plane with the conductors incorporated in the circuit disposed in said plane.

However, the conductive securement of the IC circuit to the antenna continues to pose problems in that it increases the thickness of the assemblage and prevents the utilization of such combinations in many applications such as miniaturized RFID tags.

Consequently, in ultra-miniature circuits, for example RFID tags, miniaturizing circuit dimensions and decreasing production costs are ongoing objectives. Recent patents teach methods of implementing this miniaturization with respect to attachment of the integrated circuits to the antenna by the simplest, lowest profile and most economical means conceived of at the time (e.g., Marsh-Patent No. 5,566,441 and Moskovitz-Patent No. 5,528,222).

Objects And Advantages Of The Invention

15

20

An object of my invention is the provision of a circuit for eliminating conductors between the IC components of an RFID and the associated antenna materially reducing the overall cost and increasing the utility of the IC/antenna combination.

Another object of my invention is the provision of an RFID circuit wherein the electrical conductors between electronic circuit elements are supplanted by electromagnetically reactive capacitive coupling means, utilizing electrically conductive areas such as inks, films, or foils on thin insulating dielectric substrates.

Another object of my invention is the provision of circuits of the aforementioned character

wherein inductive coupling means are utilized in substitution for said capacitive coupling means.

An additional object of my invention is the provision of circuitry of the aforementioned character wherein the conductive and capacitive coupling means are supplanted by the utilization of lumped coupling means.

5

A further object of my invention is the incorporation of an RFID circuit of the aforementioned character in an identification device utilizing flexible substrates, such as, for example, sheet polymer materials utilized in identification wristbands wherein the components of the RFID can be placed on superimposed strips of polymer sheets and electronic communication between the components of the RFID is established by capacitive coupling means.

An additional object of my invention is a provision of an assemblage of the aforementioned character wherein the capacitive coupling means is supplanted by inductive coupling means.

A further object of my invention is the provision of an RFID assemblage mounted in a flexible
identification wristband formed from flexible polymers
wherein superimposed laminae of said flexible polymers
include an RFID circuit incorporating lumped electronic
conductor means.

Other objects and advantages of my invention will be apparent from the following specification and

the accompanying drawings which are for the purpose of illustration only.

Brief Description of the Drawings

FIG. 1: shows a reactively coupled RFID tag
in capacitive coupling with a dipole
antenna;

5

10

15

- FIG. 2: is a longitudinal sectional view taken on the line 2-2 of Fig. 1;
- FIG. 3: shows the coupling circuit means of Figs. 1 and 2;
- FIG. 4: is a block diagram of the components of Figs. 1-3;
- FIG. 5: is an RFID tag with capacitively coupled antenna elements on opposite sides of the flexible substrate; and
- FIG. 6: is the circuit of Fig. 5.

Description of Preferred Embodiments of the Invention

Referring to the drawings, and particularly to Figs. 1 and 2 thereof, I show an integrated circuit chip 10 mounted on one surface of an elongated flexible substrate 12 such as a polymer strip and having a reactively coupled capacitive connection to a dipole antenna 14 on the other side of said strip.

There are various ways of attaching an inte-25 grated circuit to a substrate consisting of a polymeric film and, in the case of chip 10, the operative connec-

tion thereof to the substrate may be accomplished by adhesive means.

The antenna 14 may be imprinted on the opposite sides of the substrate by the utilization of conductive inks or may be provided in the form of conductive foils adhesively or otherwise secured in underlying relationship with the IC chip 10.

The capacitive coupling of the chip 10 to the antenna 14 is accomplished by terminal areas 17 on the chip 10 which overlie corresponding extremities 16 of the antenna 14. The terminal areas 17 of the chip 10 are electrically connected to the circuitry of the chip 10.

In addition to providing operative coupling,

the capacitance (reactance) between the IC and the substrate can be utilized as a capacitative component in a resonant RFID antenna circuit or other resonant circuit.

tronic circuit elements on opposite sides of a thin insulating dielectric film at appropriate frequencies, capacitive, inductive, or lumped reactive interconnection or coupling of the elements may be obtained by placing appropriate conducting areas or patterns on opposite sides of the film at the point of coupling. This can be accomplished by the adhesive attachment of

conductive foils or printing of conductive inks on the opposite sides of the film.

By the capacitive coupling of circuit elements, the need for electrical connections constituted by conductors through windows or vias in the substrate is eliminated. Consequently, the production of functional circuits by printing or similar processes in a continuous production line is simplified and enhanced. Moreover, the overall thickness and consequent size of the package is greatly reduced.

The circuit 18 of Fig. 3 shows the chip 10 connected to the dipole antenna 14 by the capacitive coupling 19. The capacitance of the overlying terminal areas 17 of the chip 10 and the extremities 16 of the dipole antenna 14 can be calculated by the formula for a parallel plate capacitor:

C(in farads) = er*eo*A/d

where

10

15

20

er is the relative dielectric constant eo is the permittivity of free space,

8.85*10^-12 farads/meter

A is the plate area in m^2

and d is the separation between the plates,
A is the area of the overlap, d is the distance between
the plates, er is the dielectric constant of the substrate 12, and eo is the permittivity of free space,

8.85*10^-12 farads/meter constant. Thus, for an overlap area of 4 sq. millimeters, a distance of 0.1mm, and a dielectric constant 3.0, the capacitance of the coupling circuit is 1.062 pico-farads.

At a frequency of 2.4 GHz, the impedance of the capacitive reactance is equal to 62 ohms, which will resonate a circuit whose reactance is inductive on the order of 62 ohms. Assuming dimensions of the dipole antenna formed by the conductive antenna portions 14 are 2.6" of the total length by 1/8", then an antenna is formed which is resonant at 2.4 GHz. The circuit 18 is shown in Fig. 3 of the drawings wherein the capacitance 19 between the terminal areas 17 of the IC and the extremities of the antenna 14 is illustrated.

RFID tag incorporating the circuit elements of Figs. 1
3. A Reader-Programmer radiates an electromagnetic field to supply the tag with power and to communicate with the tag. The dipole antenna elements 14 are connected by the capacitive/inductive circuit 19 to an antenna interface 28 and the antenna interface is connected on one side to a power supply 30 which supplies power to control circuitry 32 and data storage 42, said data storage and computer circuitry being mutually

interconnected to a modulator 44 which is, in turn, connected to the antenna interface 28.

The power supply circuit 30 derives power by rectifying the voltage induced in the antenna 14. The 5 RFID tag receives information by variations in the reader field and transmits signals to the reader by impressing a modulation signal on the antenna interface. Control circuits provide logic, timing, and control signals to the components of the tag IC appropriate for the complexity of the tag function and its communication protocol. Data storage circuitry 42 in the tag provides information storage ranging from A READ-ONLY ID number to a READ-WRITE database.

An alternative antenna arrangement is shown
in Figs. 5 and 6 of the drawings as including overlapping antennas 52 and 54 on opposite surfaces of the
substrate 50, the antenna 52 being of substantially
truncated rectangular construction and the antenna 54
being of substantially loop construction and located
internally of the antenna 52. Overlapping areas 56 of
the antenna introduce series capacitances in the
antenna elements.

At a frequency range of 900 MHz, capacitive coupling of the IC to the antenna is practical, but the effective length of the antenna must be longer than for operation at 2.4 GHz. In this case, the coupling is

used to provide antenna elements on both sides of the substrate with the antenna 52 located on one side of the substrate and the antenna 54 located on the other side of the substrate with the overlapping areas located in spaced relationship with each other through the medium of the polymer of the substrate.

The IC chip 60 is located in overlapping relationship with the bi-polar extremities of the antenna 52 and establishes a capacitive coupling in the manner previously described. In turn, the opposite 10 extremities of the antenna 52 are disposed in overlapping capacitive relationship with the extremities of the antenna 54 on the other side of the substrate. this manner, the length of the antenna is extended and much more capacitive reactance is provided. It should 15 be kept in mind that series inductance between antenna elements increases the electrical length of the antenna and series capacitance decreases it. The antenna can be electrically longer by adding more elements and using capacitance to provide the connection. However, 20 the capacitance must be of low impedance so as not to defeat the added elements.

Illustrated in Fig. 6 is the circuitry of the dual antenna combination wherein the dual capacitance is illustrated at 66 in relationship to the integrated

25

circuit 60. The loop antenna 54 is capacitively connected to the antenna 52 by the capacitances 66.

By the utilization of the dual antennae, the resultant is the equivalent of an antenna which is long enough to be resonant with the designed circuitry.

Although I have disclosed specific reactive circuitry utilized in conjunction with a polymer substrate, it will be obvious to those skilled in the art that alternative circuitry may be utilized without departing from the scope and spirit of the invention as defined in the claims.

I CLAIM:

15

1. In a radio frequency circuit, the combination of:

a polymeric substrate; and

- components of said circuit formed on opposite surfaces of said substrate in overlying relationship with each other whereby the resistance of said polymeric substrate creates a reactive relationship between said components.
- 10 2. In a radio frequency circuit, the combination of:

a polymeric substrate; and

components of said circuit formed on opposite surfaces of said substrate in overlying relationship with each other whereby the resistance of said polymeric substrate creates an inductive relationship between said components.

- 3. In a radio frequency circuit, the combination of:
- substrate means including a plurality of polymeric laminae secured in overlying relationship with one another, said laminae including a top lamina, a bottom lamina, and an intermediate lamina disposed between said top and bottom laminae; and

circuit components formed on the top and bottom surfaces of said intermediate lamina to utilize said lamina as a circuit component.

- 4. The device of claim 3 wherein the circuit is a reactive circuit.
 - 5. The circuit of claim 3 wherein the circuit is an inductive circuit.
 - 6. The device of claim 1 in which the components of said circuit are imprinted in conductive ink.

10

- 7. The device of claim 1 in which the components of said circuit are fabricated from metallic foils.
- 8. The circuit of claim 1 which includes a plurality of antennae formed on opposite sides of said lamina in overlying relationship with each other.
 - 9. The circuit of claim 8 in which said antennae are operatively connected by a reactive circuit.
- 20 10. The circuit of claim 8 in which said antennae are operatively connected by an inductive circuit.
 - 11. In a circuit for an RFID, the combination of:

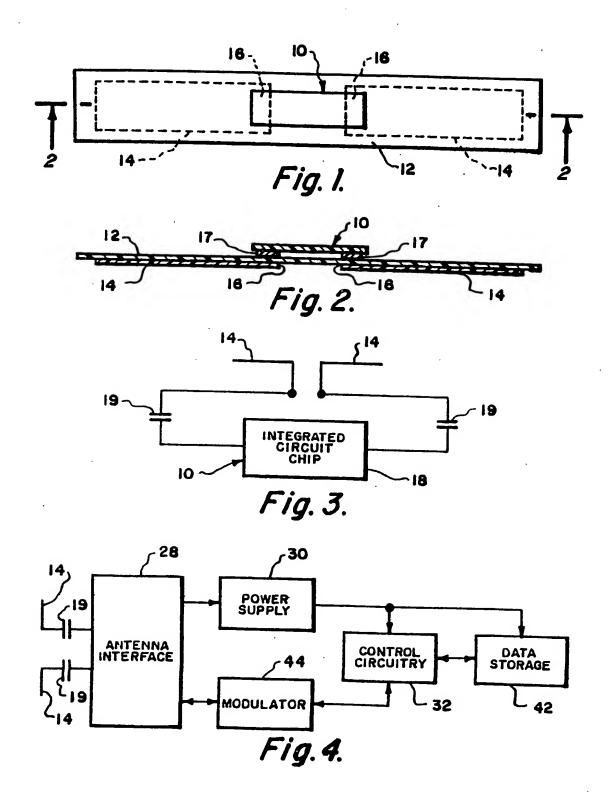
a polymeric substrate for said circuit, said substrate acting as a structural component of said RFID; and

circuit components formed on opposite surfaces of said substrate in overlying relationship
of one component with another to incorporate said
substrate as an operative component of said circuit.

12. The circuit of claim 11 which is reac
10 tive and wherein said substrate operates as the dielec
tric component of said circuit.

5

13. The circuit of claim 11 which is inductive and wherein said substrate operates as the dielectric component of said circuit.



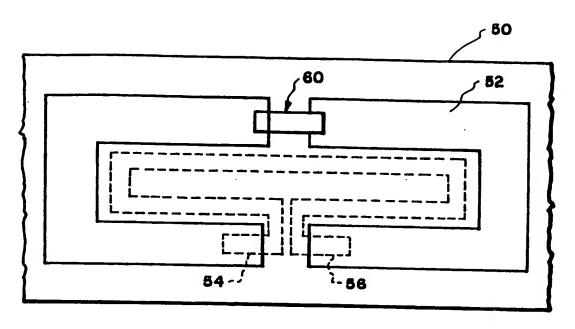
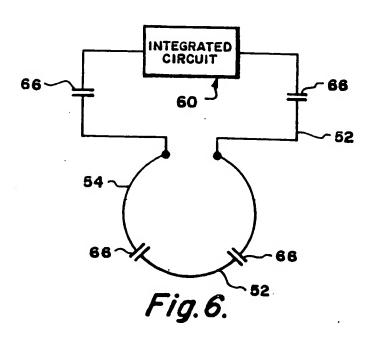


Fig. 5.



INTERNATIONAL SEARCH REPORT

International application No. PCT/US98/04099

L. CLASSIFICATION OF SUBJECT MATTER									
1PC(6) :H01Q 11/12, 1/36; G08B 13/14, 26/00 US CL : 343/726, 742, 873, 895; 343/505, 572, 825.54; 235/492									
US CL : 3	143/726, 742, 873, 893; 343/303, 572, 823-34, 233/42 International Patent Classification (IPC) or to both nation	onal classification and IPC							
	S SEARCHED								
		classification symbols)							
Minimum documentation searched (classification system followed by classification symbols)									
U.S. : 3	43/726, 742, 873, 895; 343/505, 572, 825.54; 235/492								
	to death as the minimum documentation to the ext	ant that such documents are included	n the fields searched						
Documentation searched other than minimum documentation to the extent that such documents are included in the fields searched									
NONE		•							
	as have received during the international search (name	of data hase and, where practicable,	search terms used)						
Electronic data base consulted during the international search (name of data base and, where practicable, search terms used)									
IC, ANTENNA, CAPACITY COUPLING									
		·							
C. DOC	UMENTS CONSIDERED TO BE RELEVANT								
Category*	Citation of document, with indication, where appro	priate, of the relevant passages	Relevant to claim No.						
x	US 4,835,524 A (LAMOND ET AL)	1-5, 11-13							
	figures 1 and 2.								
Y			6-10						
ľ		25 4	1-5, 11-13						
X	US 5,142,270 A (APPALUCCI ET AL)	25 August 1992 (25/06/92),	1-5, 11-15						
	figures 1-3 and column 3, lines 51-59.								
	THE SECOND AS A CONTROL OF ALL	20 3 1002 (20/06/03)	6 and 7						
Y	US 5,223,849 A (KASEVICH ET AL)	29 Junw 1993 (29/00/93),	o and /						
	see entire document.								
1	Y US 5,608,417 A (DE VALL) 04 March 1997 (04/03/97), see entire								
Y		1997 (04/03/97), see chare	8-10						
	document.								
1									
1	,								
1									
Fu	ther documents are listed in the continuation of Box C.	See patent family annex.							
<u> </u>		*T ^o later document published after the it	stamational filing date or priority						
	document defining the general state of the art which is not considered	date and not in coullist with the ap the principle or theory underlying	plication but cited to understand						
	to be of particular relevance	"X" document of particular relevance;	the claimed invention cannot be						
.B.	earlier document published on or after the international filling date	considered novel or cannot be consi when the document is taken alone							
7.	document which may throw doubts on priority claim(s) or which is cited to establish the publication data of another citation or other	"Y" document of particular relevance;	the claimed invention cannot be						
	special reason (as specified)	considered to involve an inventi combined with one or more other a	ive step when the document is						
.0-	document referring to an oral disclosure, use, exhibition or other means	being obvious to a person skilled	n the est						
•b•	document published prior to the international filing data but later than the priority data claimed	*A* document member of the same patent femily							
Date of	he actual completion of the international search	Date of mailing of the international	search report						
11 MA	Y 1998	2 0 .1111 1009							
Name of	d mailing address of the ISA/US	Authorized officer							
Commi	ssioner of Patents and Trademarks	1 m 1 ilu							
Box Po Washir	77 gton, D.C. 20231	MIAN HO // JULY							
	e No. (703) 305-3230	telephone No. (703) 308/4040							